## 502759340 04/09/2014

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Yu-Feng Yen	04/02/2014

#### **RECEIVING PARTY DATA**

Name:	HIMAX TECHNOLOGIES LIMITED	
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City:	Tainan City	
State/Country:	TAIWAN	

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14248350

#### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	SHELLEY KUO
SIGNATURE:	/SHELLEY KUO/
DATE SIGNED:	04/09/2014

**Total Attachments: 2** source=1918116#page1.tif source=1918116#page2.tif

PATENT 502759340 REEL: 032631 FRAME: 0060

# **ASSIGNMENT OF INVENTION**

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

Name:	Yu-Feng Yen	Nationality: TW		
Hereby sells, a	ssigns and transfers to			
ASSIGNEE(S	<b>)</b> :			
Name:	HIMAX TECHNOLOGIES LIMITED			
Address:	No.26, Zih Lian Road, Fonghua Village, Xinshi Dist., Tainan City 74148, Taiwan, R.O.C.			
any and all imp	sors and assignees of the ASSIGNEE the enti- provements which are disclosed in the invention	n entitled:		
"IMAGE SENSOR MODULE AND METHOD FOR ADJUSTING FOCUS OF IMAGE SENSOR MODULE"				
Which is found in:				
(a) _ <b>+</b>	(a) U.S. patent application executed on even date			
(b) U.S. patent application executed on				
(c)	U.S. application serial no			
(d) 1	patent no issued			
(e)I	nternational application no.	_		

Assignment, Page 1 of 2

NPO#HMO-P0201-USA:0 CUST#HM-2013-0114-US

**ASSIGNOR(S) (Inventors):** 

F#NPO-P0002E-US1 DSC0-103U002329

**PATENT** 

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this APR 0 2 2014 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

**Signature of INVENTOR** 

Yu-Feng Yen

Yu-Fena Yen

Assignment, Page 2 of 2

NPO#HMO-P0201-USA:0 CUST#HM-2013-0114-US

F#NPO-P0002E-US1 DSC0-103U002329

PATENT REEL: 032631 FRAME: 0062